# **BLF7G15LS-300P**

# **Power LDMOS transistor**

**AMPLEON** 

Rev. 4 — 1 September 2015

**Product data sheet** 

## 1. Product profile

### 1.1 General description

300 W LDMOS power transistor for base station applications at frequencies from 1450 MHz to 1550 MHz.

Table 1. Typical performance

Typical RF performance at  $T_{case}$  = 25 °C in a common source class-AB production test circuit.

Mode of operation	f	I <sub>Dq</sub>	V <sub>DS</sub>	P <sub>L(AV)</sub>	Gp	η <sub>D</sub>	ACPR
	(MHz)	(mA)	(V)	(W)	(dB)	(%)	(dBc)
2-carrier W-CDMA	1476 to 1511	2600	28	85	18	31	-32 <sup>[1]</sup>

<sup>[1]</sup> Test signal: 3GPP test model 1; 64 DPCH; PAR = 7.5 dB at 0.01 % probability on CCDF per carrier. Carrier spacing 5 MHz.

#### 1.2 Features and benefits

- High efficiency
- Low R<sub>th</sub> providing excellent thermal stability
- Designed for broadband operation (1450 MHz to 1550 MHz)
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent pre-distortability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

### 1.3 Applications

RF power amplifiers for W-CDMA base stations and multi carrier applications in the 1450 MHz to 1550 MHz frequency range

## 2. Pinning information

Table 2. Discrete pinning

	_ iooi oto piiiiiig		
Pin	Description	Simplified outline	e Graphic symbol
1	drain1		,
2	drain2	1 2	<u>.</u>
3	gate1	5	3
4	gate2	3 4	5
5	source	[1]	4
			<u>'</u>
			2 sym117

[1] Connected to flange

## 3. Ordering information

Table 3. Ordering information

Type number	Packag	Package				
	Name	Description	Version			
BLF7G15LS-300P	-	earless flanged balanced LDMOST ceramic package; 4 leads	SOT539B			

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage		-	65	V
$V_{GS}$	gate-source voltage		-0.5	+13	V
$I_D$	drain current	per section	-	45	Α
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	200	°C

## 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R <sub>th(j-c)</sub>	thermal resistance from junction to case	$T_{case}$ = 80 °C; $P_{L}$ = 85 W; $V_{DS}$ = 28 V; $I_{Dq}$ = 2600 mA	0.21	K/W

### 6. Characteristics

Table 6. Characteristics

 $T_i = 25$  °C; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 2.2 \text{ mA}$	65	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$V_{DS}$ = 10 V; $I_{D}$ = 220 mA	1.5	1.9	2.3	V
I <sub>DSS</sub>	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V}$	-	-	2.8	μΑ
I <sub>DSX</sub>	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	34	39	-	Α
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 11 V; $V_{DS}$ = 0 V	-	-	280	nA
9 <sub>fs</sub>	forward transconductance	$V_{DS}$ = 10 V; $I_{D}$ = 11.0 A	-	16.2	-	S
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 7.7 \text{ A}$	-	0.065	-	Ω

### 7. Test information

#### Table 7. Functional test information

Mode of operation: 2-carrier W-CDMA; PAR = 7.5 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 64 DPCH;  $f_1$  = 1473.5 MHz;  $f_2$  = 1478.5 MHz;  $f_3$  = 1508.5 MHz;  $f_4$  = 1513.5 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 2600 mA;  $T_{case}$  = 25 °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$P_{L(AV)}$	average output power		-	85	-	W
Gp	power gain	$P_{L(AV)} = 85 W$	17	18	-	dB
RLin	input return loss	$P_{L(AV)} = 85 W$	-	-7	-6	dB
$\eta_{D}$	drain efficiency	$P_{L(AV)} = 85 W$	28	31	-	%
ACPR	adjacent channel power ratio	$P_{L(AV)} = 85 W$	-	-32	-28	dBc

#### Table 8. PAR performance

Mode of operation: 1-carrier W-CDMA; PAR = 7.5 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 64 DPCH;  $f_1$  = 1511 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 2600 mA;  $T_{case}$  = 25 °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
PAR <sub>O</sub>	output peak-to-average ratio	P <sub>L(AV)</sub> = 130 W at 0.01 % probability on CCDF	4.4	5.0	-	dB

## 7.1 Ruggedness in class-AB operation

The BLF7G15LS-300P is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 28 V;  $I_{Dq}$  = 2600 mA;  $P_{L}$  = 100 W (CW); f = 1450 MHz to 1550 MHz.

## 7.2 Impedance information

Typical impedance per section (for the maximum peak power)

 $I_{Dq} = 1300 \text{ mA}; V_{DS} = 28 \text{ V}.$  $Z_{S}$  and  $Z_{L}$  defined in Figure 1.

f	Z <sub>S</sub>	Z <sub>L</sub>
(MHz)	$(\Omega)$	$(\Omega)$
1410	0.65 – j2.06	6.3 – j2.1
1480	0.55 – j1.92	7.2 – j1.3
1560	0.63 – j2.14	6.8 + j0.26

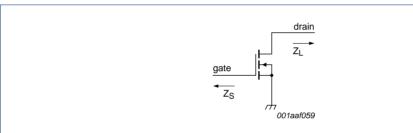
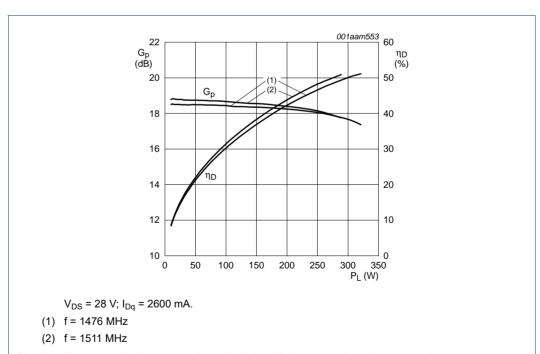


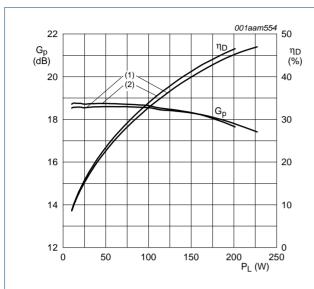
Fig 1. **Definition of transistor impedance** 

## 7.3 Graphs



One-tone CW power gain and drain efficiency as function of load power; Fig 2. typical values

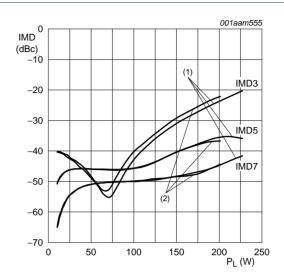
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 $V_{DS}$  = 28 V;  $I_{Dq}$  = 2600 mA; tone spacing 0.1 MHz.

- (1) f = 1476 MHz
- (2) f = 1511 MHz

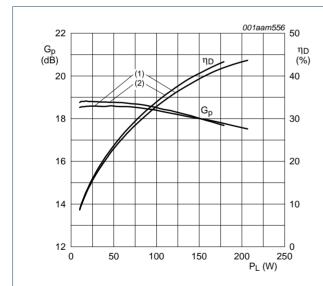
Fig 3. Two-tone CW power gain and drain efficiency as function of average load power; typical values



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 2600 mA; tone spacing 0.1 MHz.

- (1) f = 1476 MHz
- (2) f = 1511 MHz

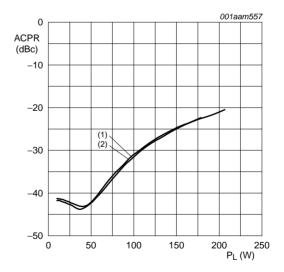
Fig 4. Two-tone intermodulation distortion as a function of average load power; typical values



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 2600 mA; carrier spacing 5 MHz.

- (1) f = 1476 MHz
- (2) f = 1511 MHz

Fig 5. 2-carrier W-CDMA power gain and drain efficiency as function of load power; typical values

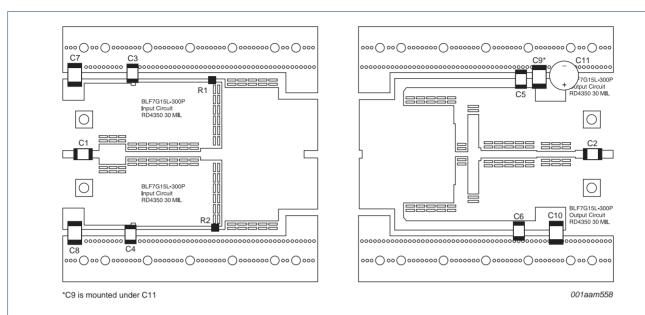


 $V_{DS}$  = 28 V;  $I_{Dq}$  = 2600 mA; carrier spacing 5 MHz.

- (1) f = 1476 MHz
- (2) f = 1511 MHz

Fig 6. 2-carrier W-CDMA adjacent channel power ratio as function of load power 5 MHz frequency offset; typical values

#### 7.4 Test circuit



Rogers RO4350 Printed-Circuit Board (PCB) with  $\varepsilon_r$  = 3.5 and thickness = 0.765 mm (30 mil).

See  $\underline{\text{Table 10}}$  for list of components. The drawing is not to scale.

The vias can be as a reference to place components.

The above layout shows the test circuit used to measure devices in production. The RF Power and Base-Station group can provide a more appropriate application demonstration for specific customer needs.

Fig 7. Component layout

Table 10. List of components

See Figure 7 for test circuit.

Component	Description	Value	Remarks
C1, C2	multi layer ceramic chip capacitor	100 pF [1]	ATC 800B
C3, C4	multi layer ceramic chip capacitor	68 pF [1]	ATC 800B
C5, C6	multi layer ceramic chip capacitor	47 pF [1]	ATC 800A
C7, C8, C9, C10	multi layer ceramic chip capacitor	10 μF	Murata
C11	electrolytic capacitor	470 μF; 63 V	
R1, R2	chip resistor	15 Ω	Philips 1206

[1] All ATC chip capacitors need to be soldered vertically.

## 8. Package outline

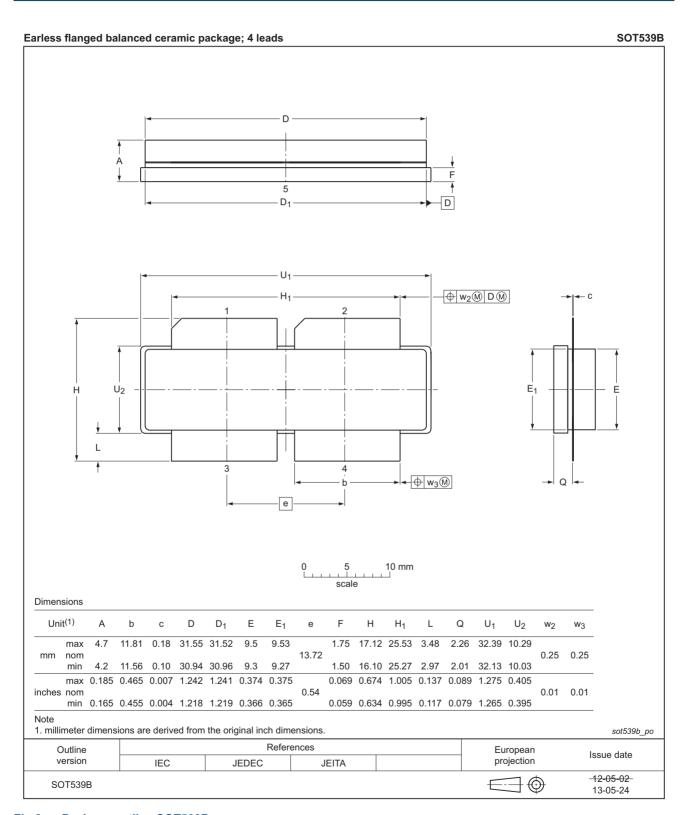


Fig 8. Package outline SOT539B

## 9. Abbreviations

Table 11. Abbreviations

Acronym	Description
3GPP	Third Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
ESD	ElectroStatic Discharge
LDMOS	Laterally Diffused Metal Oxide Semiconductor
LDMOST	Laterally Diffused Metal Oxide Semiconductor Transistor
PAR	Peak-to-Average power Ratio
RF	Radio Frequency
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

## 10. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BLF7G15LS-300P#4	20150901	Product data sheet	-	BLF7G15LS-300P v.3	
Modifications:	<ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
BLF7G15LS-300P v.3	20130712	Product data sheet	v company name who	BLF7G15LS-300P v.2	
BLF / G 13L3-300F V.3	20130712	Floduct data sneet	-	BLF/G13L3-300F V.2	
BLF7G15LS-300P v.2	20101203	Product data sheet	-	BLF7G15LS-300P v.1	
BLF7G15LS-300P v.1	20100921	Preliminary data sheet	-	-	

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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#### **Power LDMOS transistor**

## 13. Contents

1	Product profile	. 1
1.1	General description	. 1
1.2	Features and benefits	. 1
1.3	Applications	. 1
2	Pinning information	. 2
3	Ordering information	. 2
4	Limiting values	. 2
5	Thermal characteristics	. 2
6	Characteristics	. 3
7	Test information	. 3
7.1	Ruggedness in class-AB operation	. 3
7.2	Impedance information	. 4
7.3	Graphs	
7.4	Test circuit	. 6
8	Package outline	. 7
9	Abbreviations	. 8
10	Revision history	. 8
11	Legal information	. 9
11.1	Data sheet status	. 9
11.2	Definitions	. 9
11.3	Disclaimers	. 9
11.4	Trademarks	10
12	Contact information	10
13	Contents	11

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